



THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. 10/620,468
Confirmation No. 8630
Filing Date July 15, 2003
Inventor Dinesh Chopra
Assignee Micron Technology, Inc.
Group Art Unit 2822
Examiner T. Tran
Customer No. 021567
Attorney's Docket No. MI22-2345
Title: Conductive Connection Forming Methods, Oxidation Reducing Methods, and
Integrated Circuits Formed Thereby

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Reference -See Attached Form PTO-1449


In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, your attention is directed to the United States patents and other references listed on the attached Form PTO-1449. No admission is made regarding whether all the submitted references are prior art.

Citation of these references is respectfully requested.

Respectfully submitted,

Dated: 26 Feb 2007

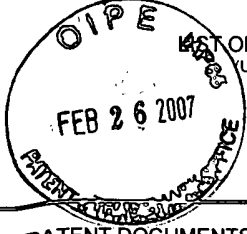
By: _____


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Form PTO-1449		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY. DOCKET NO. M122-2345		SERIAL NO. 10/620,468	
 LIST OF ART CITED BY APPLICANT (Use several sheets if necessary)				APPLICANT: Dinesh Chopra et al.			
				FILING DATE July 15, 2003		GROUP 2822	

U.S. PATENT DOCUMENTS							
*Examiner's Initials	Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate	
AA							
AB							
AC							
AD							
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FOREIGN PATENT DOCUMENTS							
Document Number	Date	Country	Class	Subclass	Translation		
					Yes	No	
AJ	JP 6-69270	06/1994	Japan				
AK							
AL							

OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)			
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	AN		
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.